

AN11xxx

TWR-POSCARD Hardware description

Rev. 1.1 — July 2, 2019

Application note
COMPANY CONFIDENTIAL

Document information

Info	Content
Keywords	TWR-POS-CLRC663, SPI, E.M.V, Kinetis, CLRC663, TDA8035
Abstract	This application note describe the TWR_POSCARD evaluation board to be used with NXP's Kinetis K80 family chip.



Revision history

Rev	Date	Description
1.0	20190514	Initial revision
1.1	20190702	Added section 3. With FCC part 15 Warning statements

Contact information

For more information, please visit: <http://www.nxp.com>

1. Presentation

TWR-POS-RC663 is a peripheral module board to be used with NXP's Tower system.

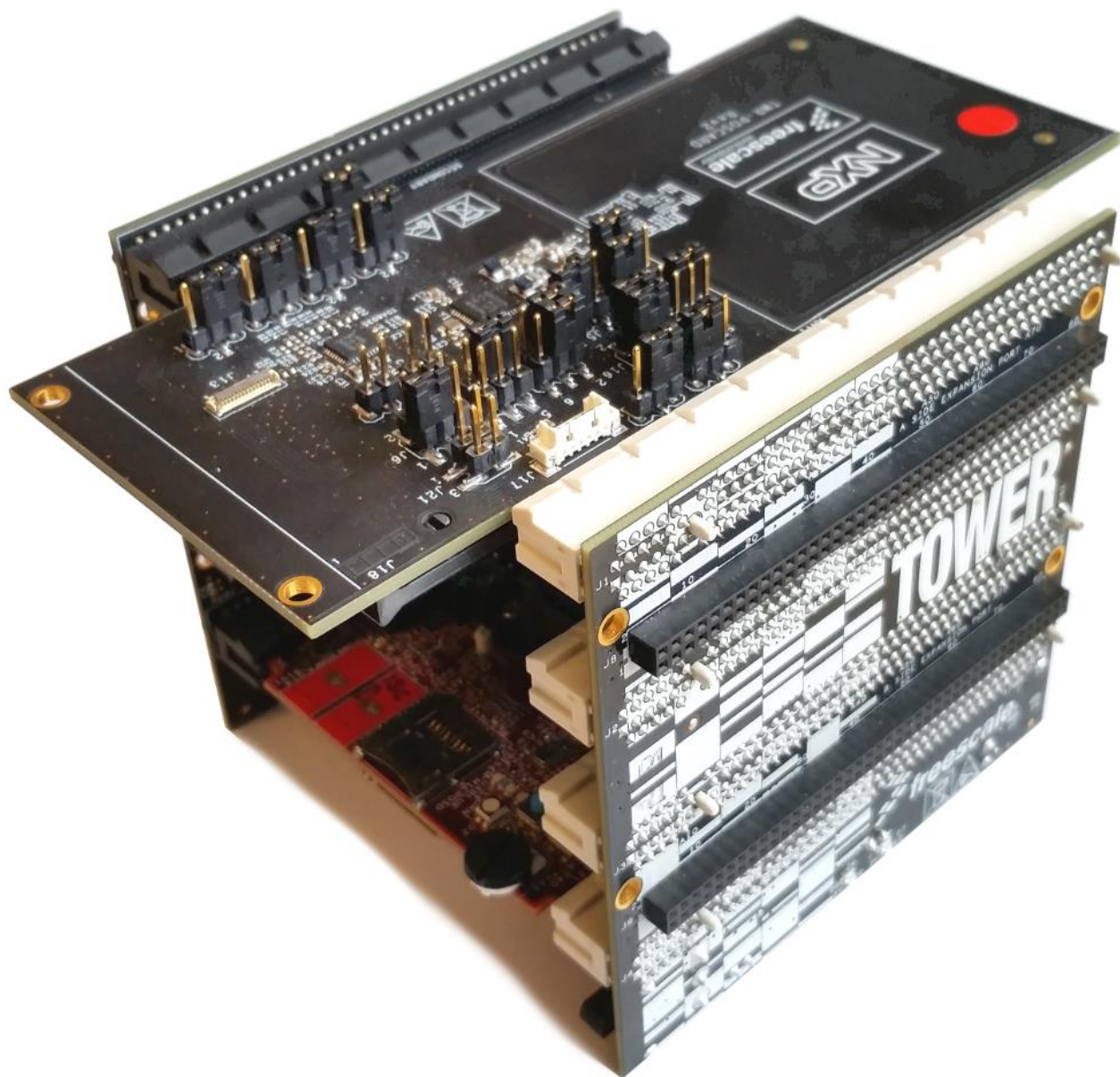


Fig 1. Tower System

1.1 Daughter board

TWR-POS-CLRC663 is a peripheral board that can be plugged into a tower system to add Contact and Contactless EMV reader functionality.

TWR-POS-CLRC663 is the below board:



Fig 2. TWR-POSCARD V2 Top view

This board can be plugged as in Fig 1, using the TWR-ELEV boards (side connector boards).

When plugging this board, the Primary and Secondary connection sides have to be respected. PCI secondary and primary connector are identified on TWR-POS-CLRC663, and on TWR-ELEV card, see below figure.

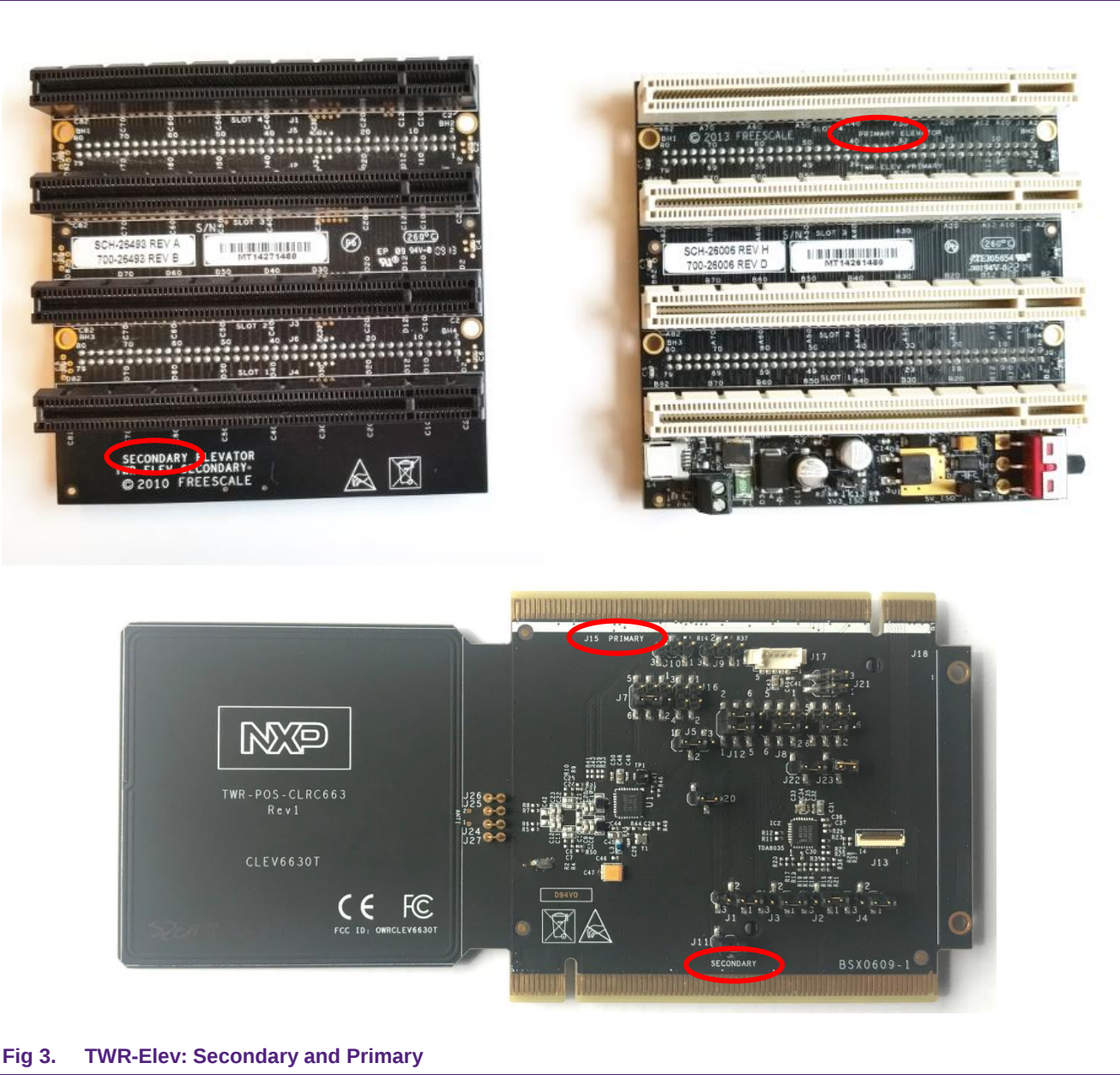


Fig 3. TWR-Elev: Secondary and Primary

1.2 Architecture

The TWR-POS-CLRC663 peripheral board embeds ICs to provide Contact and Contactless payment functionalities.

The board uses the following ICs:

- CLRC663: NXP Contactless Front-end reader
- TDA8035: NXP Contact Front-end reader device.

Both devices are compliant with latest payment specifications (EMVCo)

The reader ICs are controlled by an MCU or processor module, through the side connectors, plugged on Tower system.

In order to interface with smart cards, the TWR-POS-CLRC663 board is autonomous as it embeds an antenna connected to CLRC663 to interact with Contactless cards, and a contact smart card connector, connecting the smart card to the TDA8035.

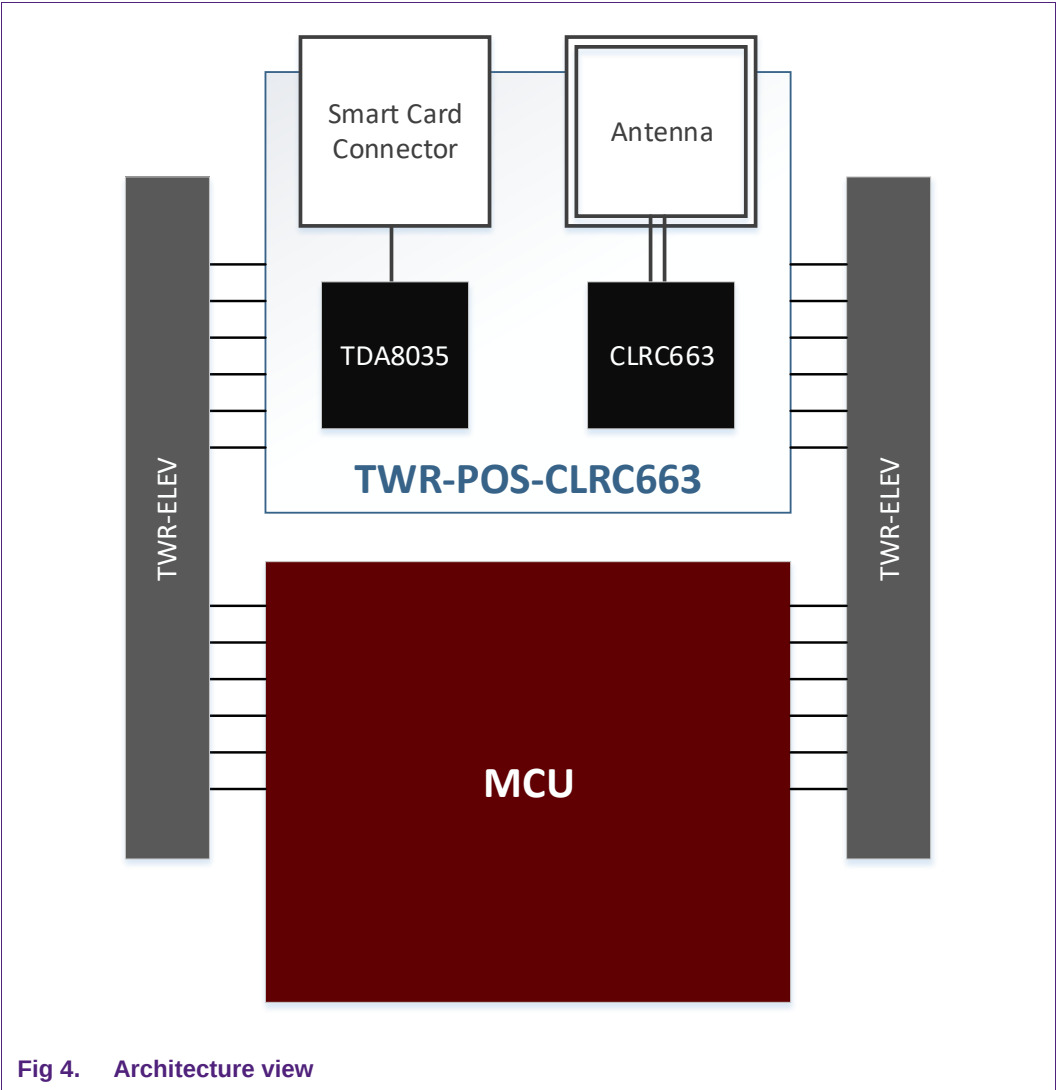


Fig 4. Architecture view

1.3 Configuration

The TWR-POS-CLRC663 peripheral board embeds several configuration jumpers. They are used to enable several Tower MCU or processor modules to be used as the controller.

Below table shows the default configuration when the TWR-K80F150M is used as the MCU module. Other configurations can be set depending on the MCU or processor module board that is used.

Table 1. Configuration jumpers for K81

Jumper Name	Function	Options (default in bold)	Connection
J1	CLRC663 CS	SPI1_CS0 - Pin B9 on Elevator SPI0_CS0 - Pin B46 on Elevator	1-2 2-3
J2	CLRC663 SPI MISO	SPI1_MISO - Pin B11 on Elevator SPI0_MISO - Pin B44 on Elevator	1-2 2-3
J3	CLRC663 SPI MOSI	SPI1_MOSI - Pin B10 on Elevator SPI0_MOSI - Pin B45 on Elevator	1-2 2-3
J4	CLRC663 SPI SCL	SPI1_CLK - Pin B7 on Elevator SPI0_CLK - Pin B48 on Elevator	1-2 2-3
J5	CLRC663 IRQ	IRQ_A - Pin B62 on Elevator IRQ_F - Pin B57 on Elevator	1-2 2-3
J6	TDA8035 Presence N	PWM3 - Pin A37 on Elevator GPIO14 - Pin A50 on Elevator ULPI_DATA1 - Pin C22 on Elevator	1-3 3-5 4-6
J7	TDA8035 Clock input	PWM1 - Pin A39 on Elevator PWM0 - Pin A40 on Elevator I2S1_DIN_SCK - Pin C58 on Elevator	1-3 3-5 4-6
J8	TDA8035 RSTIN	GPIO17 - Pin A53 on Elevator PWM2 - Pin A38 on Elevator I2S1_DIN_WS - Pin C59 on Elevator	1-3 3-5 4-6
J9	TDA8035 IOUC	ETH_RXDV_1 - Pin A16 on Elevator I2S0_DOUT_SCK - Pin A22 on Elev.	1-2 2-3
J10	TDA8035 IOUC	UART0_TX - Pin A42 on Elevator UART1_TX - Pin A44 on Elevator	1-2 2.3
J11	TDA8035 IOUC	I2S1_DOUT1 - Pin C61 on Elevator	1-2
J12 1-3-5	TDA8035 CMDVCCN	ULPI_DATA4 - Pin C25 on Elevator GPIO1 - Pin B21 on Elevator	1-3 3-5
J12 2-4-6	TDA8035 OFFN	IRQ_C - Pin B60 on Elevator IRQ_B - Pin B61 on Elevator	2-4 4-6

Jumper Name	Function	Options (default in bold)	Connection
J16 1-2	Connect MCU_ICC_PDA37	PWM3 - Pin A37 on Elevator	1-2
J16 3-4	Connect MCU_ICC_RST_A38	PWM2 - Pin A38 on Elevator	3-4
J20	CLRC663 PDOWN	SPI1_CS1 - Pin B58 on Elevator	1-2
J21 1-2	Connect MCU_MSR_DATA	TMR1 - Pin A33 on Elevator	1-2
J21 3-4	Connect MCU_MSR_STROBE	TMR0 - Pin A34 on Elevator	1-2
J22	Connect MCU_ICC_CVVV_SEL0	GPIO3 - Pin B23 on Elevator	1-2
J23	Connect MCU_ICC_CVVV_SEL1	GPIO9 - Pin A9 on Elevator	1-2

2. Design files

2.1 Schematics

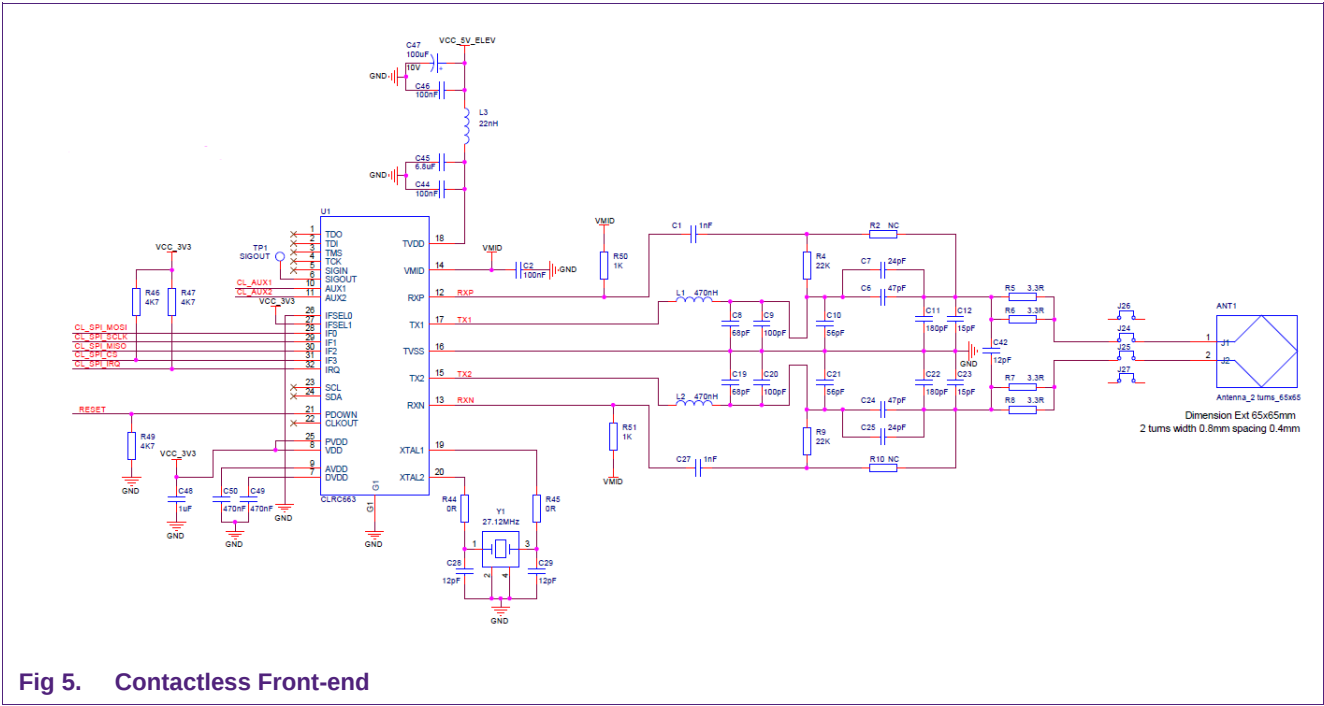


Fig 5. Contactless Front-end

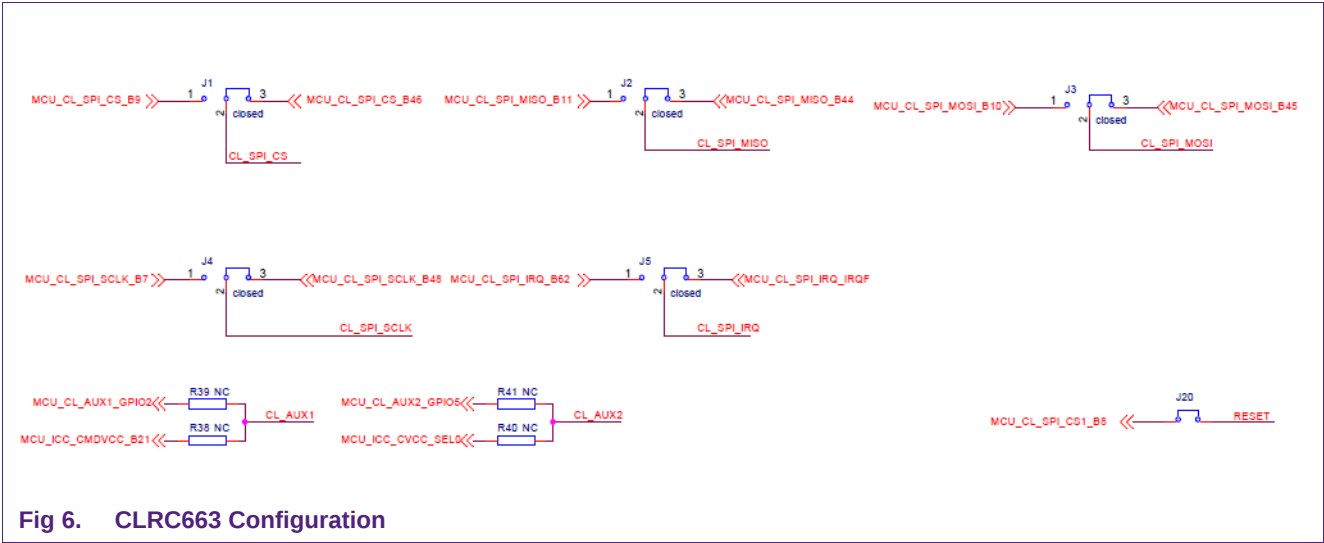
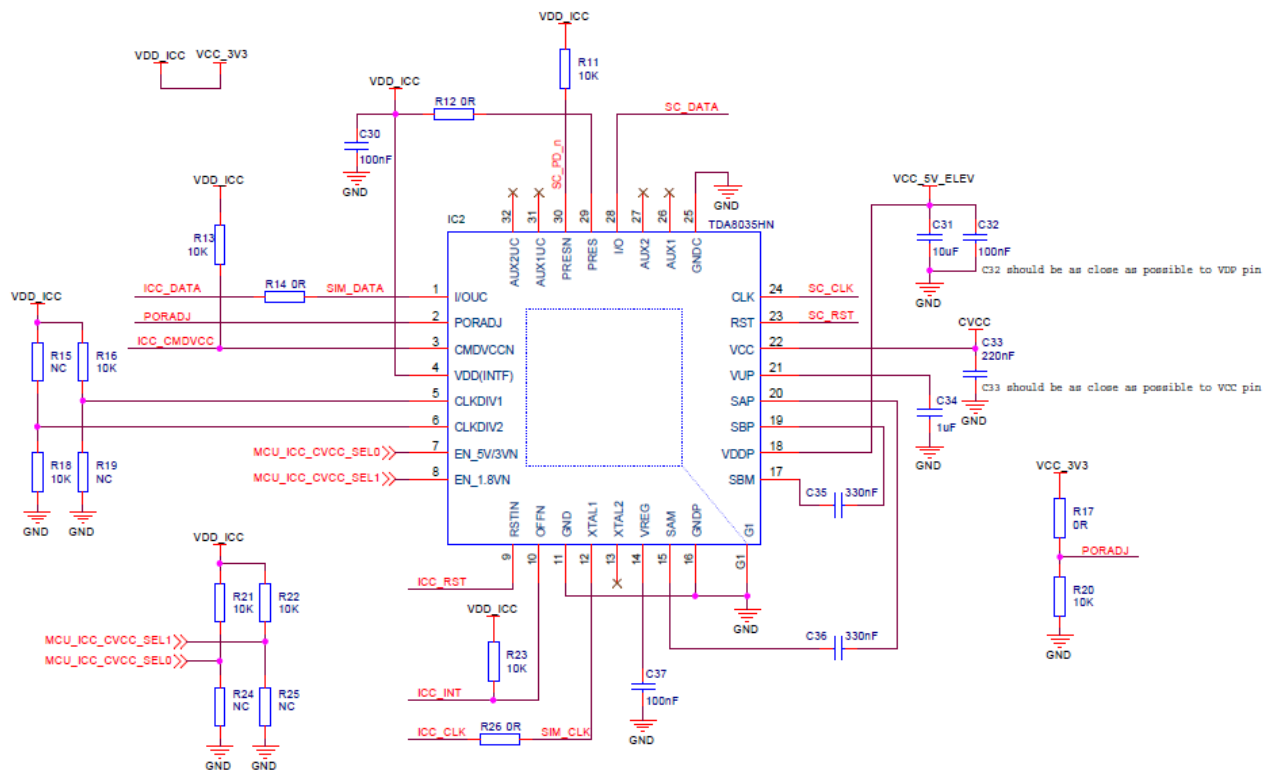
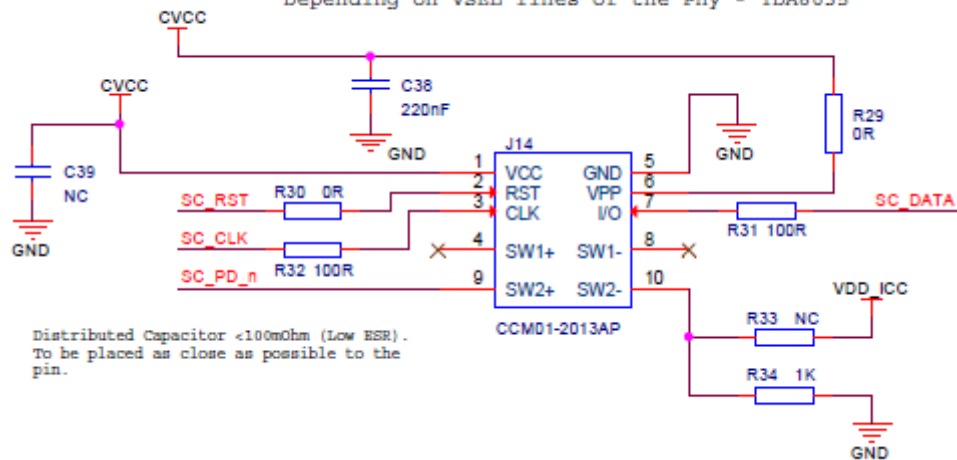


Fig 6. CLRC663 Configuration



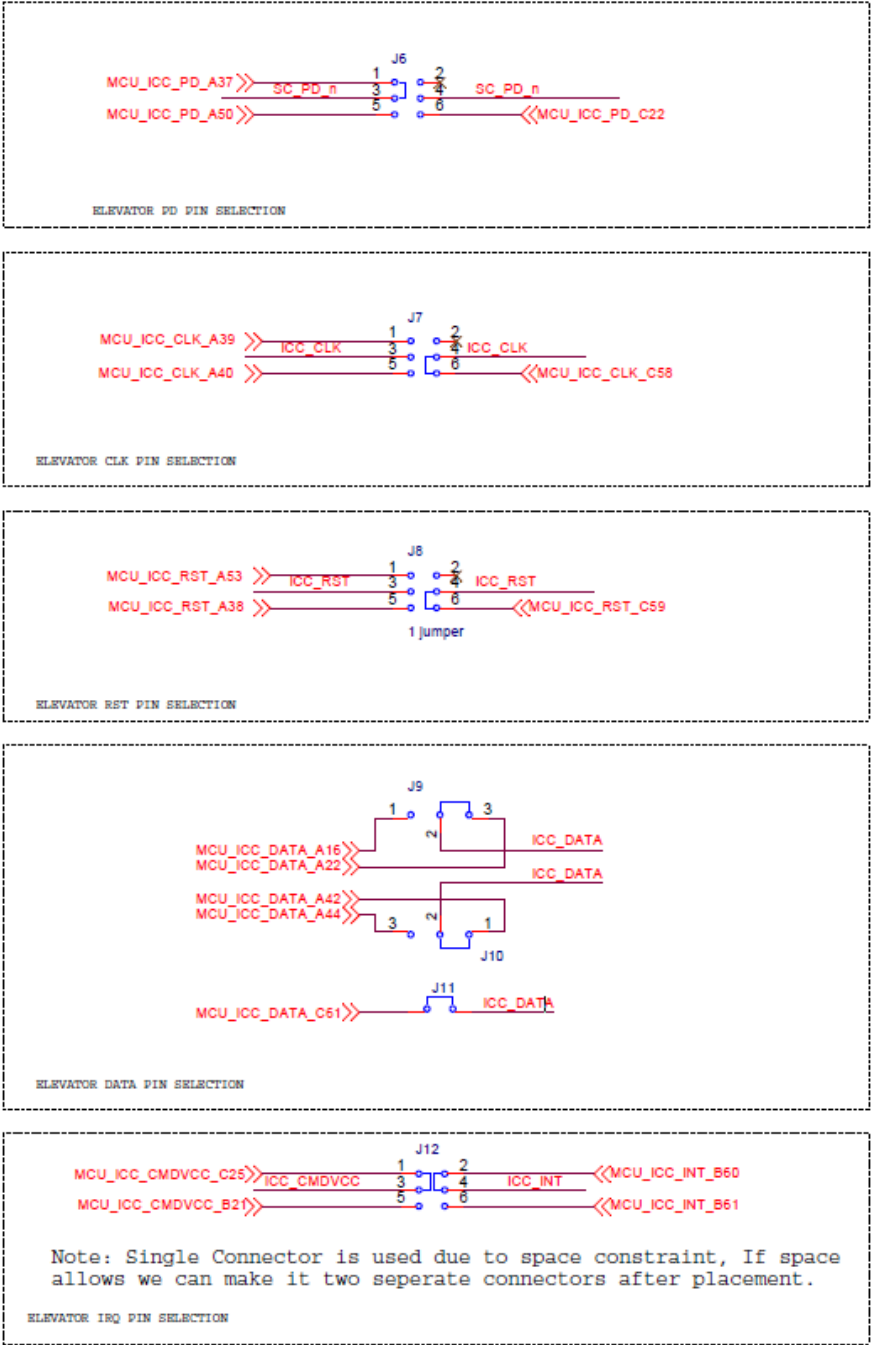
Card Power Supply:

Depending on VSEL lines of the Phy - TDA8035



Distributed Capacitor <100mOhm (Low ESR).
To be placed as close as possible to the pin.

Fig 7. TDA8035



Jumper table

HDR	JUMPER SETTINGS
J1	1-3 or 3-5 or 4-6
J2	1-3 or 3-5 or 4-6
J3	1-3 or 3-5 or 4-6
J7	(1-3 or 3-5) and (2-4 or 4-6)

Fig 8. Contact Jumper settings

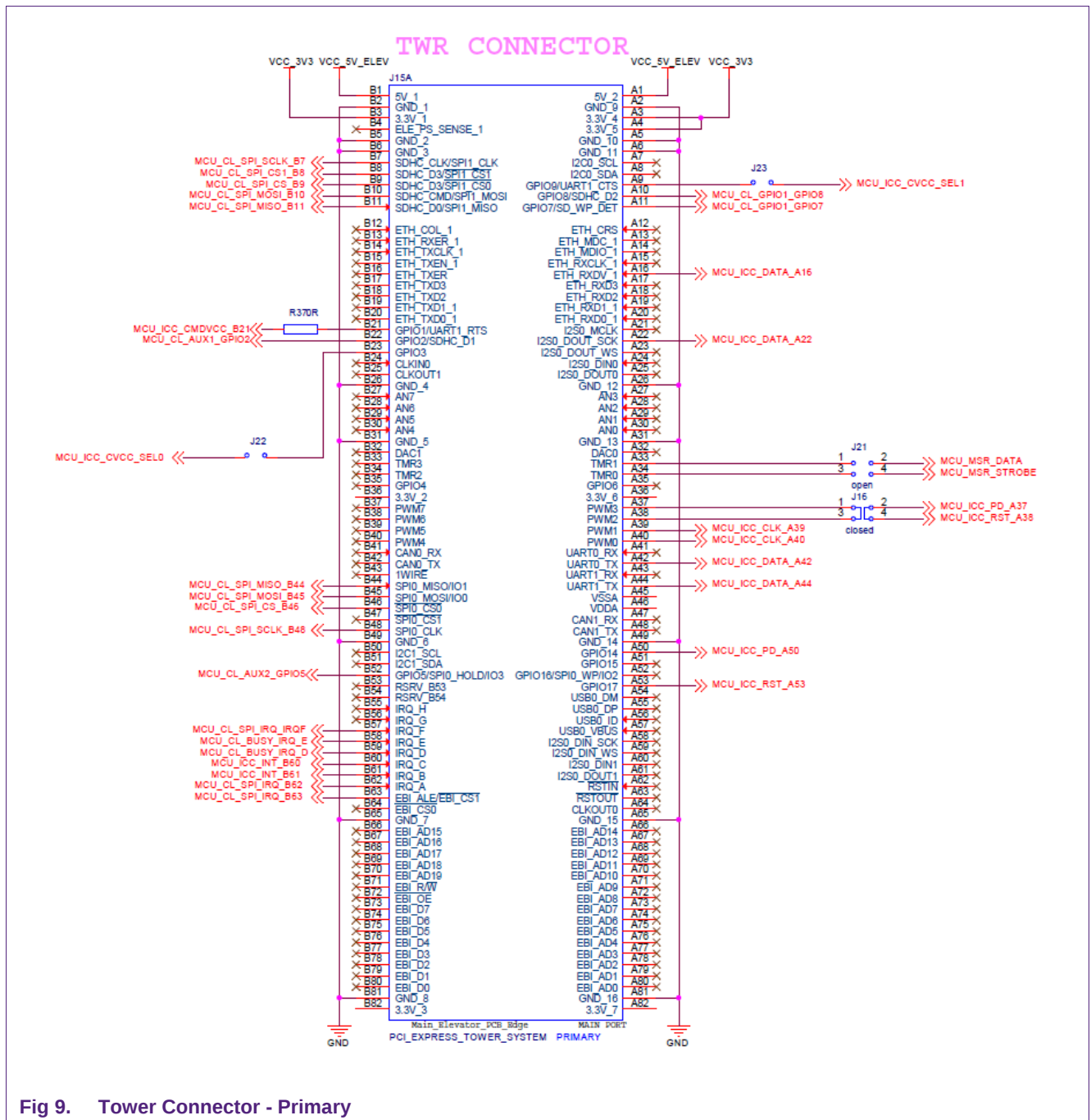


Fig 9. Tower Connector - Primary

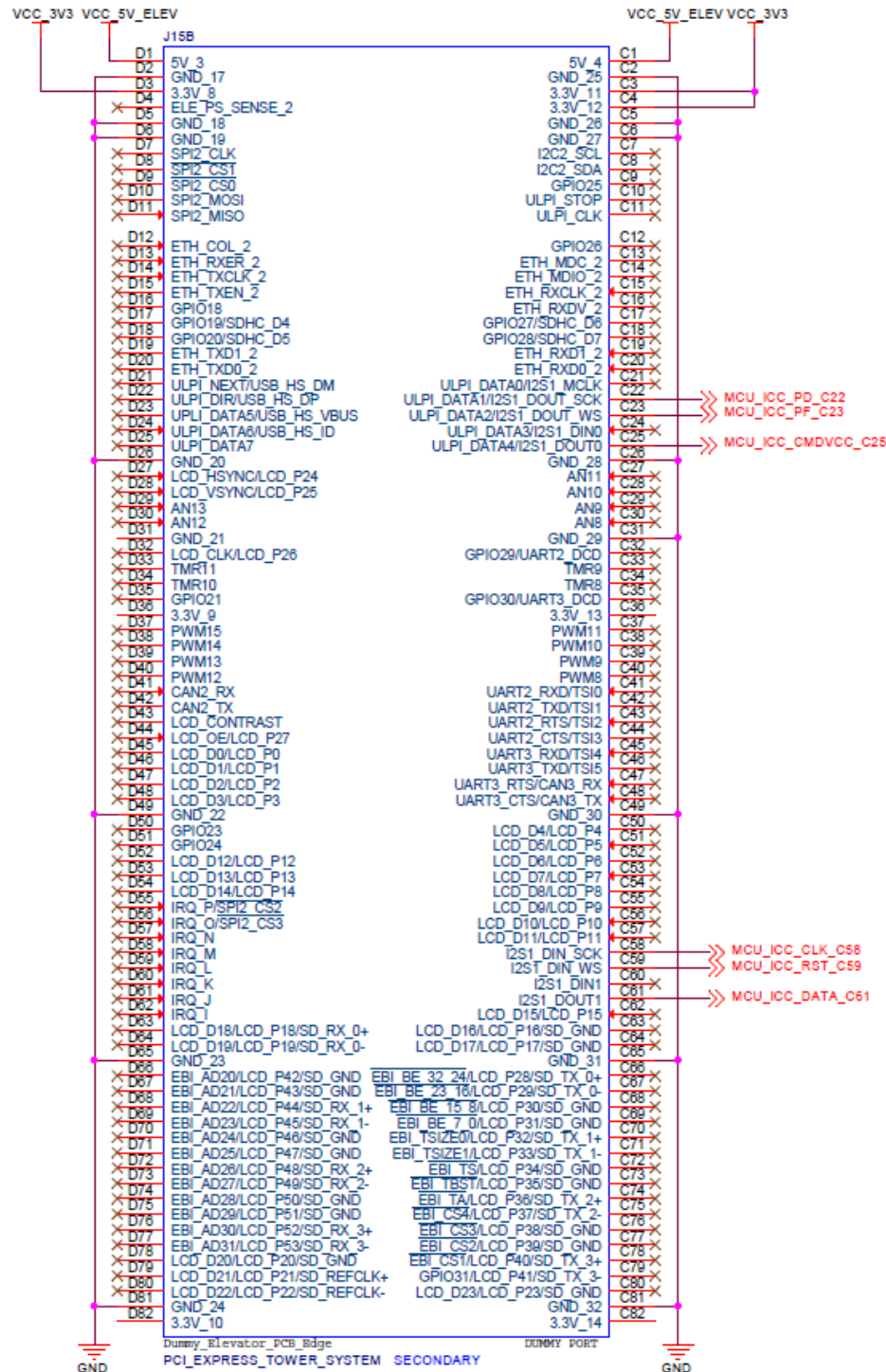


Fig 10. Tower Connector - Secondary

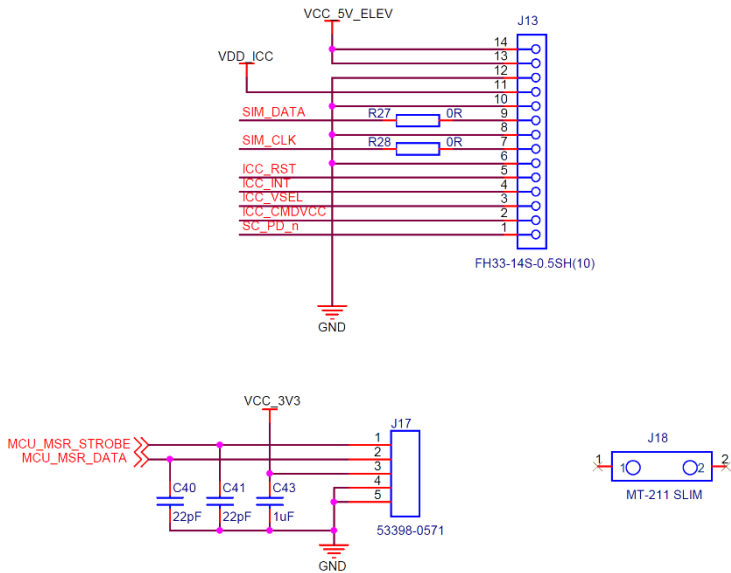


Fig 11. Other

2.2 Layout and placement

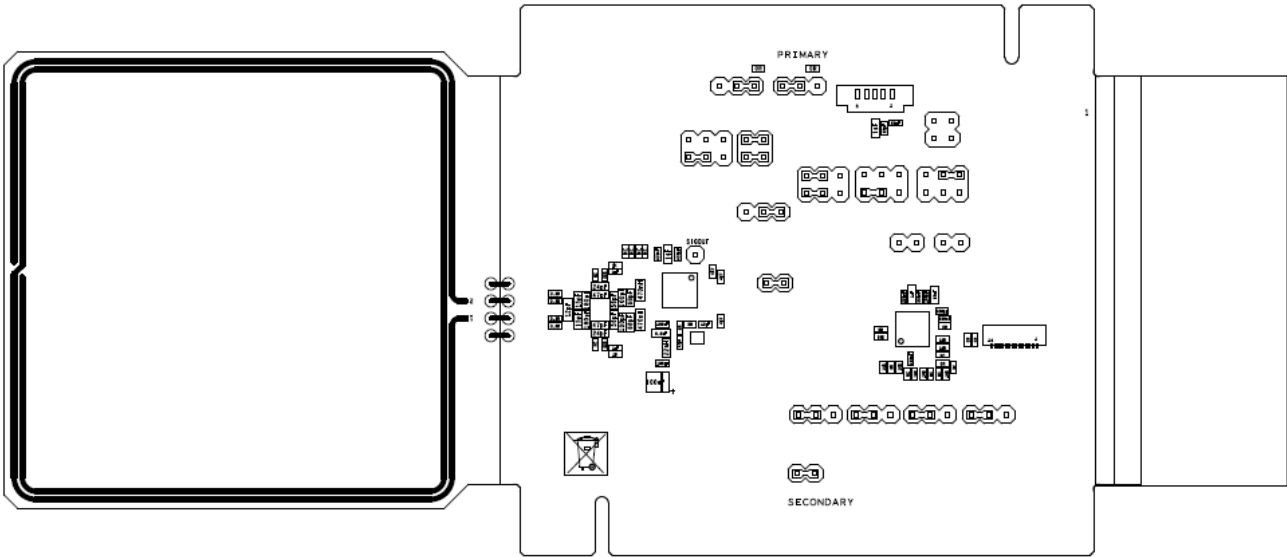


Fig 12. Board placement

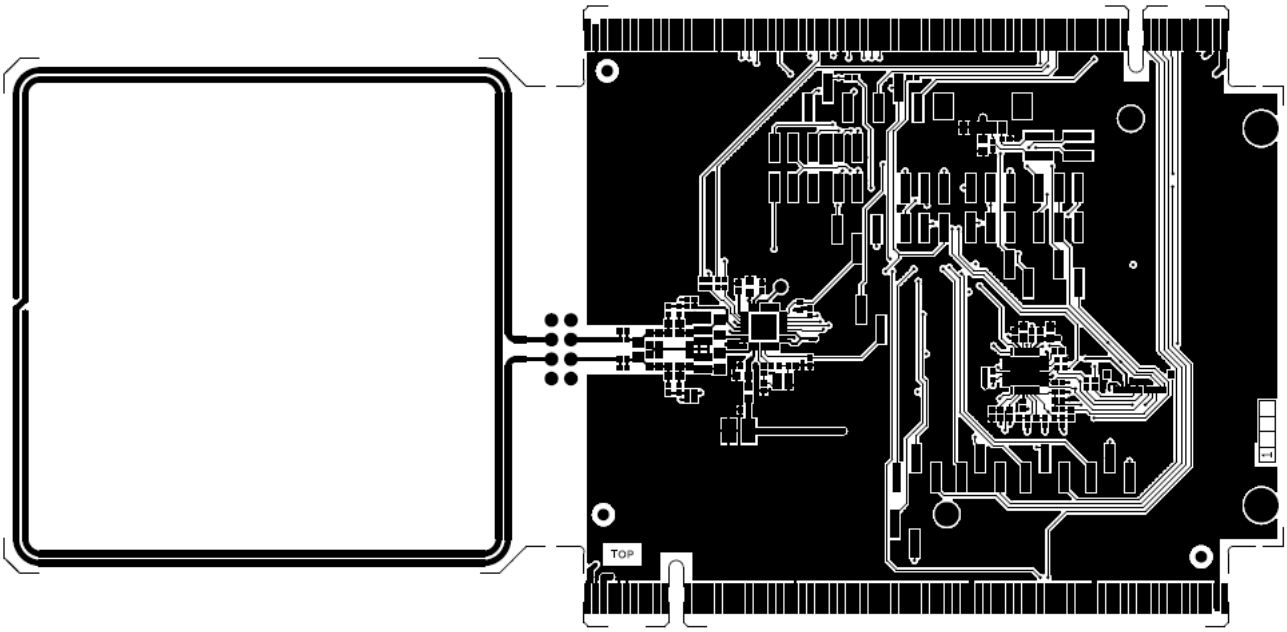


Fig 13. Layout TOP

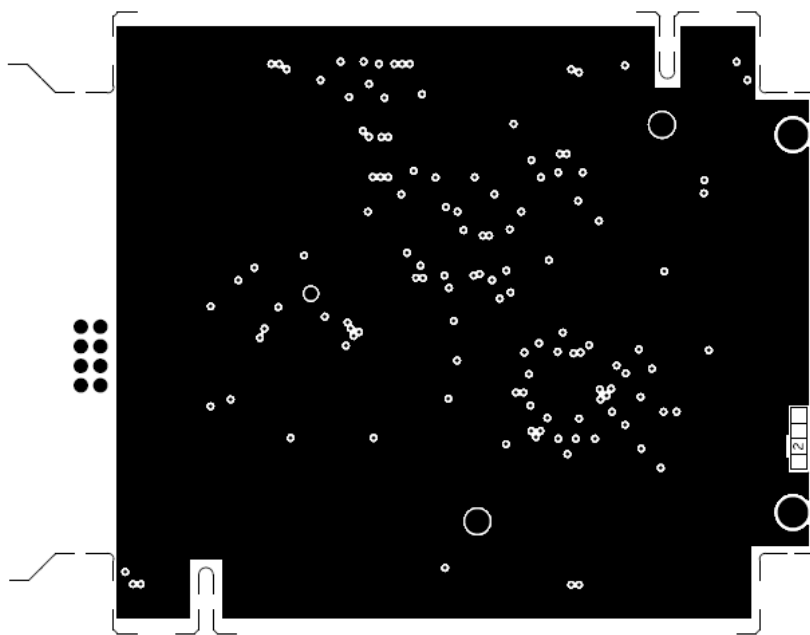


Fig 14. Layer in #1

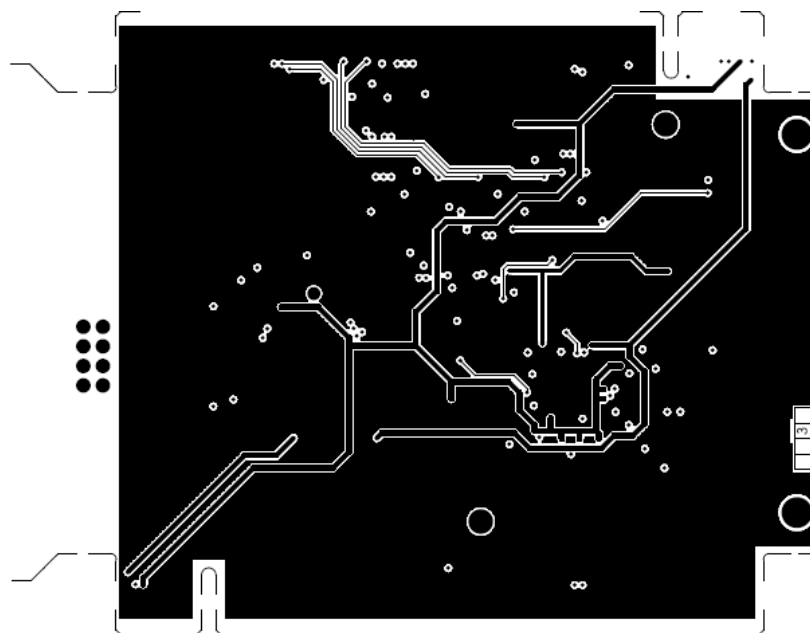


Fig 15. Layer in #2

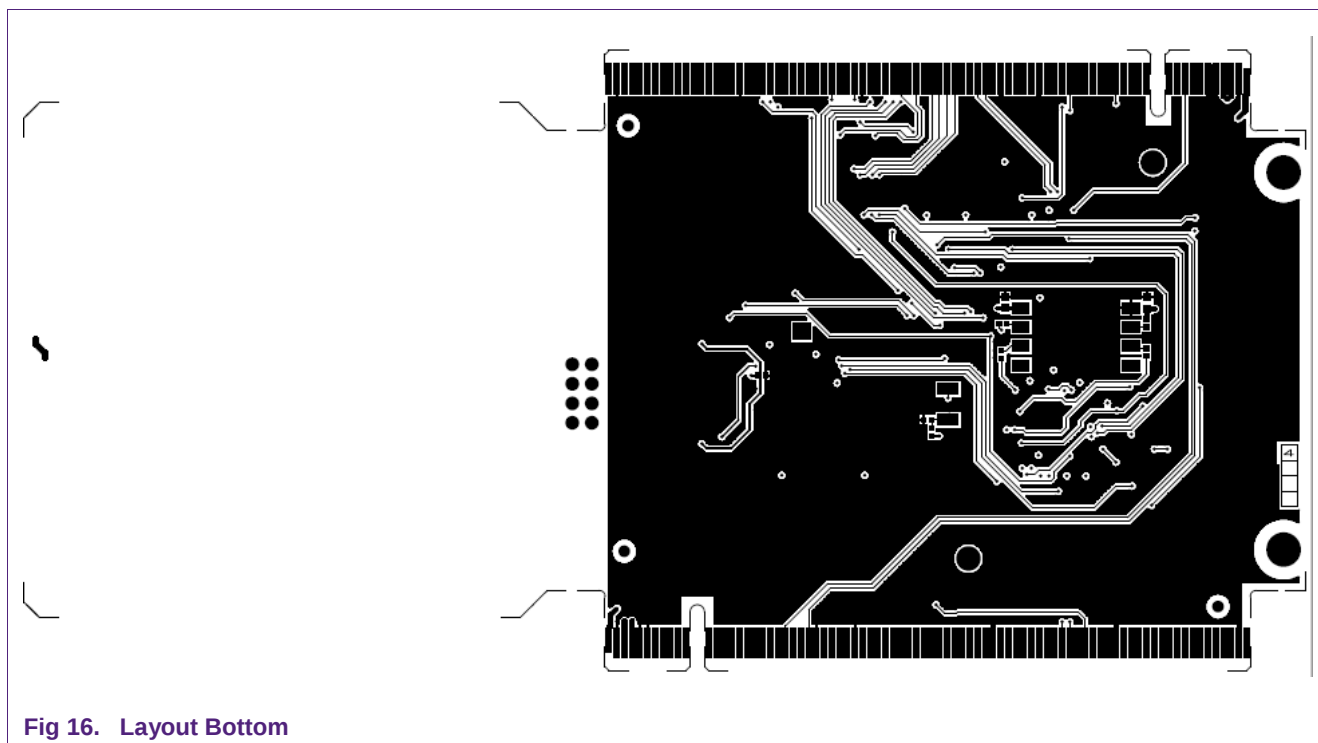


Fig 16. Layout Bottom

3. FCC Part 15 Warning Statements

3.1 FCC Part 15.19 Warning Statement

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This equipment generates uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

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- ☐ Increase the separation between the equipment and receiver.
- ☐ Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- ☐ Consult the dealer or an experienced radio/TV technician for help.

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